

P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ)		
- 60	0.070 at V _{GS} = - 10 V	- 25	30		
- 00	0.082 at V_{GS} = - 4.5 V	- 30	50		

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

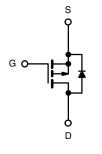
APPLICATIONS

- High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display



TO-252

Top View



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise note)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	- 60	V			
Gate-Source Voltage	V _{GS} ± 20		V			
Continuous Drain Current ($T_{,1} = 150 \ ^{\circ}C$)	T _C = 25 °C	I_	- 25			
Continuous Drain Current (1) = 150°C)	T _C = 100°C	- I _D -	- 20			
Pulsed Drain Current		I _{DM}	- 75	A		
Avalanche Current, Single Pulse	L = 0.1 mH	I _{AS}	- 22]		
Repetitive Avalanche Energy, Single Pulse ^a	L = 0.1 mm	E _{AS}	24.2	mJ		
Power Dissinction	T _C = 25 °C	PD	38.5 ^c	- w		
Power Dissipation	T _A = 25 °C	- 'D	2.3 ^{b, c}			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Martine to Anthing b	t ≤ 10 s	R _{thJA}	17	21	°C/W	
Maximum Junction-to-Ambient ^b	Steady State		45	55		
Maximum Junction-to-Case		R _{thJC}	2.7	3.25		
Notes:						

a. Duty cycle \leq 1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

HALOGEN

Available

d. Based up on $T_C = 25 \ ^{\circ}C$.



Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I _D = - 250 µA	- 60			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1		- 3	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0$ V, $V_{GS} = \pm 20$ V			± 100	nA
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 150 $^{\circ}$ C			- 125	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V$, $V_{GS} = -10 V$	- 20			Α
		V _{GS} = - 10 V, I _D = - 10 A	0.070			Ω
Drain-Source On-State Resistance ^a	Brach	V_{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C				
Drain-Source On-State Resistance*	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C		0.115	Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5 \text{ A}$		0.082		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A		22		S
Dynamic ^b						
Input Capacitance	C _{iss}			1000		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz		130		
Reverse Transfer Capacitance	C _{rss}			90		
Total Gate Charge ^c	Qg			30	45	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -10$ A		4.5		
Gate-Drain Charge ^c	Q _{gd}	1		7		
Gate Resistance	Rg	f = 1 MHz		7		Ω
Turn-On Delay Time ^c	t _{d(on)}			8	15	
Rise Time ^c	t _r	V_{DD} = - 30 V, R _L = 3 Ω		9	15	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 19 A, V_{GEN} = - 10 V, R_g = 2.5 Ω		80		ns
Fall Time ^c	t _f			30	45	
Drain-Source Body Diode and Characte	eristics (T _C = 2	5 °C) ^b				
Continuous Current	I _S				- 25	
Pulsed Current	I _{SM}				- 75	A
Forward Voltage ^a	V _{SD}	I _F = - 19 A, V _{GS} = 0 V		- 1	- 1.5	V
Reverse Recovery Time	t _{rr}	I _F = - 19 A, di/dt = 100 A/μs		41	61	ns

Notes:

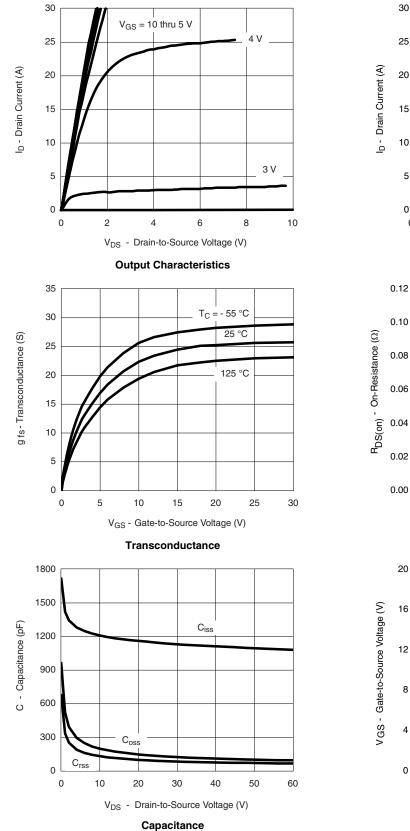
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

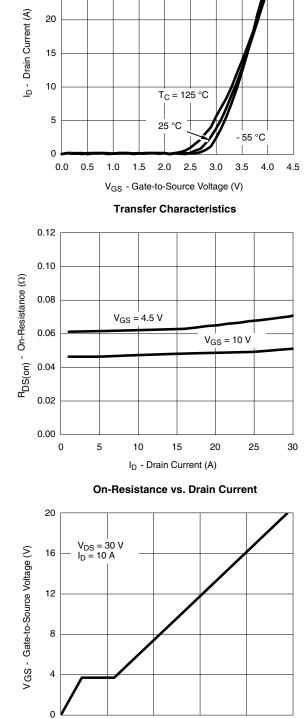
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





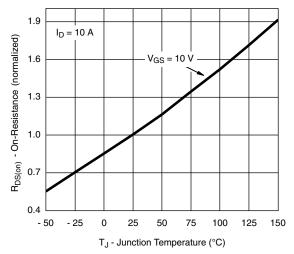
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Q_g - Total Gate Charge (nC) Gate Charge



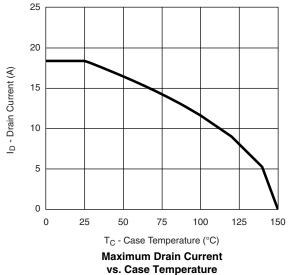


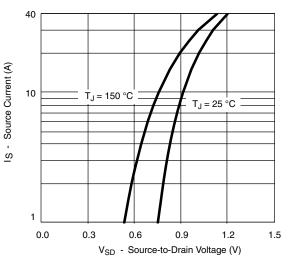


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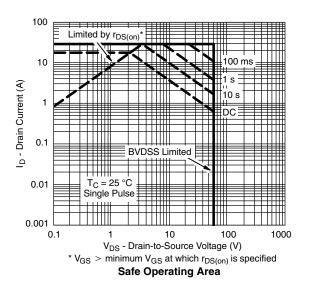


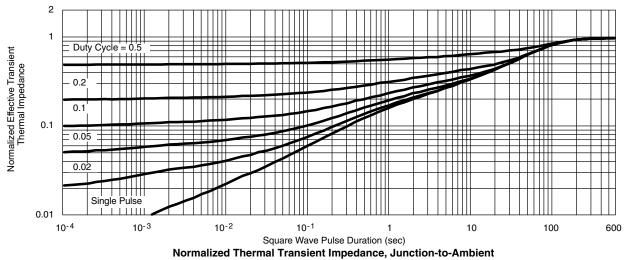






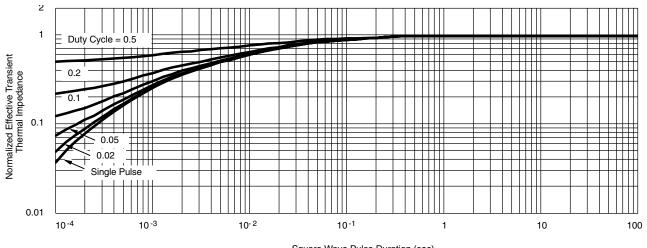
Source-Drain Diode Forward Voltage







THERMAL RATINGS

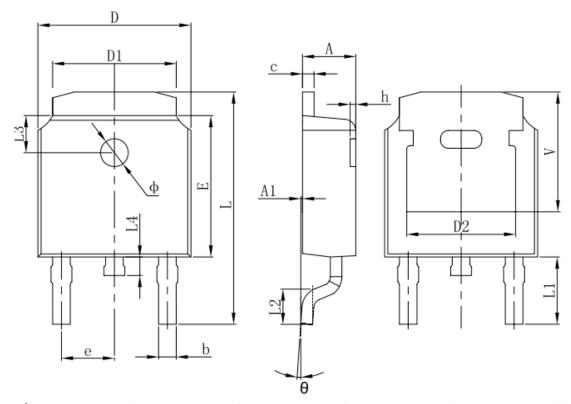


Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Case



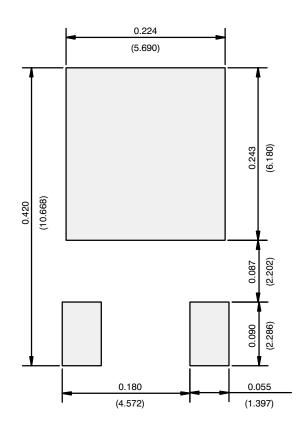
TO252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.635	0.770	0.025	0.030	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	4.830 REF.		REF.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.712	10.312	0.382	0.406	
L1	2.900	REF.	0.114 REF.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	REF.	0.063 REF.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.250	REF.	0.207 REF.		



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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